

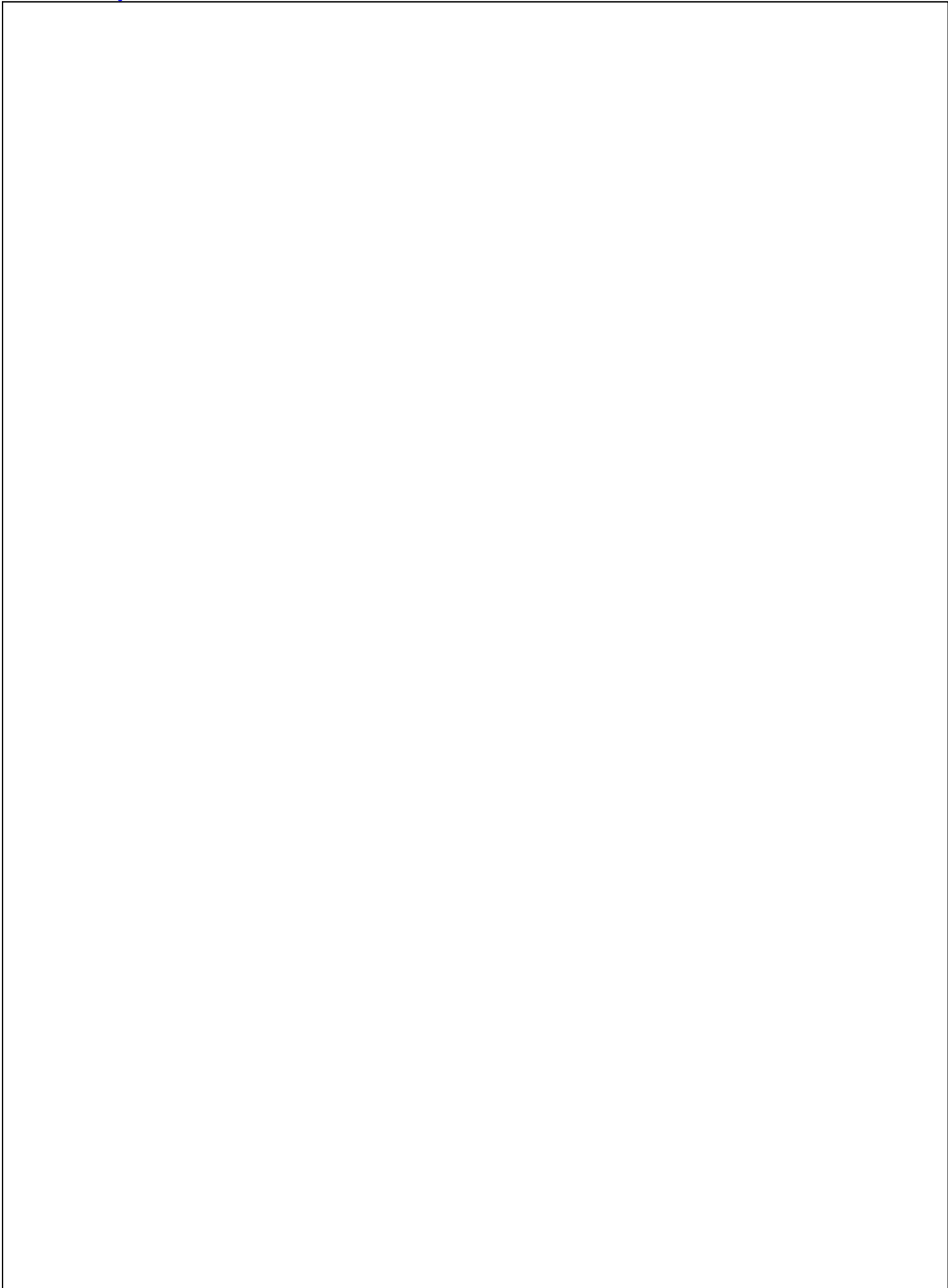


### Absolute Maximum Ratings at Ta=25

Parameter	MAX.	Unit
Power Dissipation	180	mW
Continuous Forward Current	100	mA
Peak Forward Current <sup>*2</sup>	1000	mA
Reverse Voltage	5	V
Electrostatic Discharge (HBM) <sup>*3</sup>	2000	V
Moisture Sensitivity Level <sup>*1</sup>	5a	
Operating Temperature	-40 to + 85	
Storage Temperature	-40 to + 100	
IR Reflow Temperature	260 for 10 Seconds MAX.	

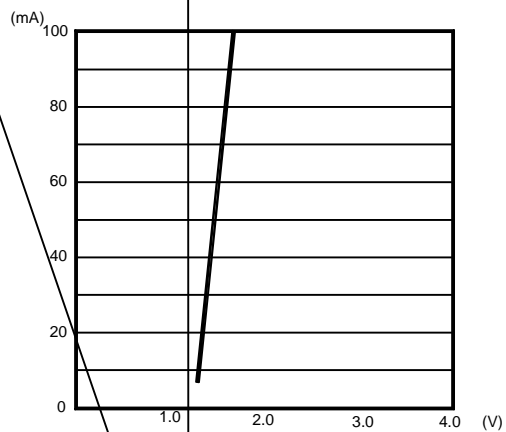
#### 1. Storage and operating:

(1). Storage requirements before vacuum bag opened: Temperature<30 , HumHBT 0 g .0(e.7(.84 Tm87 c



## Typical Electrical / Optical Characteristics Curves

(25 Ambient Temperature Unless Otherwise Noted)



0.5

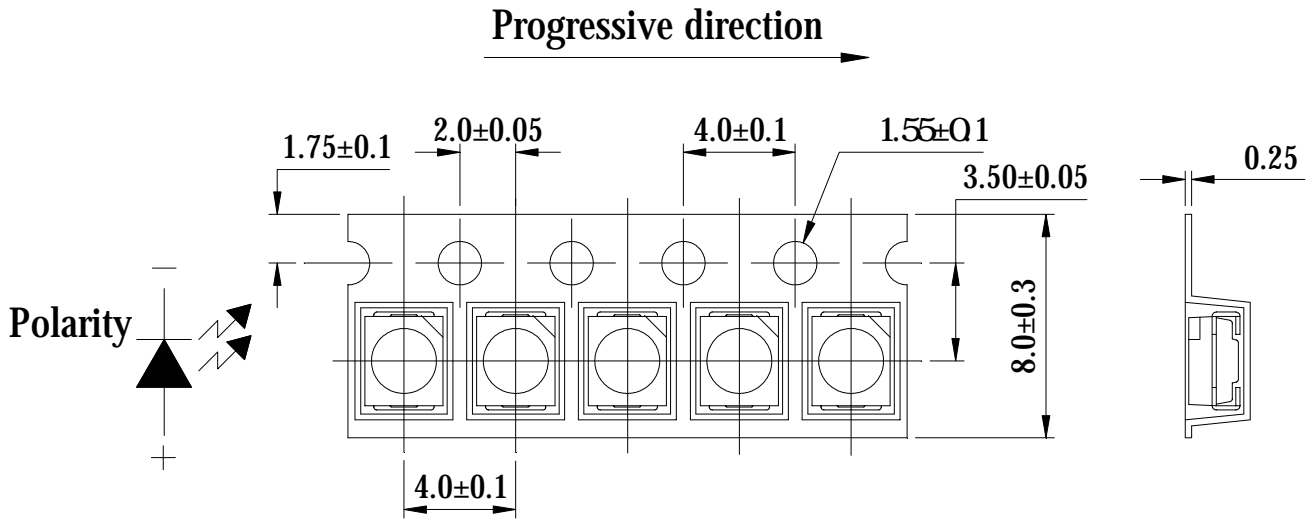
### Radiant Intensity Bin Code ( $I_F=20\text{mA}$ )

BIN CODE	Min.(mW/sr)	Max. (mW/sr)
0	1.7	1.8
1	1.8	2.0
2	2.0	2.3
3	2.3	2.8

**NOTE:** The  $I_e$  guarantee should be added  $\pm 15\%$  tolerance.

**LIGHT ELECTRONICS CO., LTD.**

## Carrier Tape Specifications (Loaded Quantity: 2000pcs/reel)

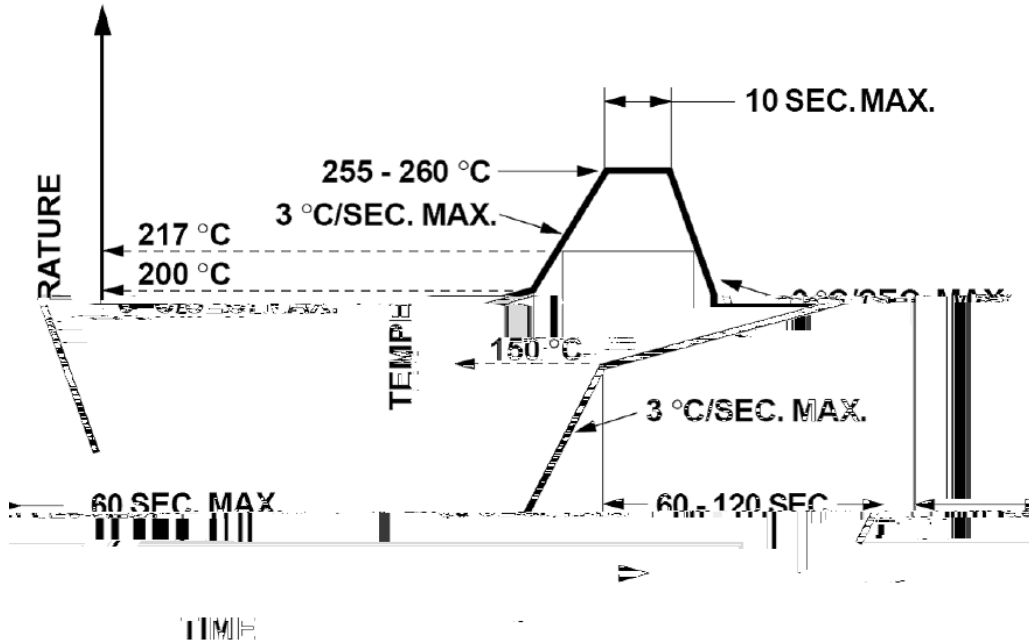


**Note:** Tolerance unless mentioned is ±0.1mm; Unit = mm

## Moisture Resistant Packaging



## Suggest IR Reflow Condition For Lead Free



1. Reflow soldering should not be done more than two times.
2. When soldering, do not put stress on the LEDs during heating.

## Soldering iron

1. When hand soldering, the temperature of the iron must less than 300 for 3 seconds.
2. The hand solder should be done only once.

## Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of LEDs will or will not be damaged by repairing.

